

CA3086

General Purpose NPN Transistor Array

May 2001

Applications

- Three Isolated Transistors and One Differentially Connected Transistor Pair For Low-Power Applications from DC to 120MHz
- General-Purpose Use in Signal Processing Systems Operating in the DC to 190MHz Range
- Temperature Compensated Amplifiers
- See Application Note, AN5296 "Application of the CA3018 Integrated-Circuit Transistor Array" for Suggested Applications

Ordering Information

PART NUMBER (BRAND)	TEMP. RANGE (°C) PACKAGE		PKG. NO.
CA3086	-55 to 125	14 Ld PDIP	E14.3
CA3086M (3086)	-55 to 125	14 Ld SOIC	M14.15
CA3086M96 (3086)	-55 to 125	14 Ld SOIC Tape and Reel	M14.15

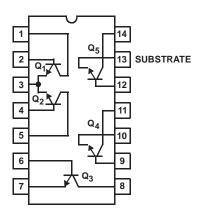
Description

The CA3086 consists of five general-purpose silicon NPN transistors on a common monolithic substrate. Two of the transistors are internally connected to form a differentially connected pair.

The transistors of the CA3086 are well suited to a wide variety of applications in low-power systems at frequencies from DC to 120MHz. They may be used as discrete transistors in conventional circuits. However, they also provide the very significant inherent advantages unique to integrated circuits, such as compactness, ease of physical handling and thermal matching

Pinout

CA3086 (PDIP, SOIC) TOP VIEW



CA3086

Absolute Maximum Ratings

Thermal Information

Thermal Resistance (Typical, Note 2)	θ_{JA} (°C/W)	θ_{JC} (oC/W)
PDIP Package	180	N/A
SOIC Package	220	N/A
Maximum Power Dissipation (Any one train	nsistor)	300mW
Maximum Junction Temperature (Plastic F	Package)	150 ^o C
Maximum Storage Temperature Range	65	^o C to 150 ^o C
Maximum Lead Temperature (Soldering 1	0s)	300°C
(SOIC - Lead Tips Only)		

Operating Conditions

Temperature Range -55°C to 125°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES

- 1. The collector of each transistor in the CA3086 is isolated from the substrate by an integral diode. The substrate (Terminal 13) must be connected to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action. To avoid undesirable coupling between transistors, the substrate (Terminal 13) should be maintained at either DC or signal (AC) ground. A suitable bypass capacitor can be used to establish a signal ground.
- 2. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $T_A = 25^{\circ}C$, For Equipment Design

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Collector-to-Base Breakdown Voltage	V _{(BR)CBO}	$I_C = 10\mu A, I_E = 0$	20	60	-	V
Collector-to-Emitter Breakdown Voltage	V _{(BR)CEO}	$I_{C} = 1 \text{mA}, I_{B} = 0$	15	24	-	V
Collector-to-Substrate Breakdown Voltage	V _{(BR)CIO}	$I_C = 10\mu A, I_{CI} = 0$	20	60	-	V
Emitter-to-Base Breakdown Voltage	V _{(BR)EBO}	$I_E = 10\mu A, I_C = 0$	5	7	-	V
Collector-Cutoff Current (Figure 1)	I _{CBO}	$V_{CB} = 10V, I_{E} = 0,$	-	0.002	100	nA
Collector-Cutoff Current (Figure 2)	I _{CEO}	$V_{CE} = 10V, I_B = 0,$	-	(Figure 2)	5	μА
DC Forward-Current Transfer Ratio (Figure 3)	h _{FE}	$V_{CE} = 3V$, $I_{C} = 1mA$	40	100	-	

Electrical Specifications $T_A = 25^{\circ}C$, Typical Values Intended Only for Design Guidance

PARAMETER	SYMBOL	TEST CONDITIONS		TYPICAL VALUES	UNITS
DC Forward-Current Transfer Ratio	h _{FE}	V _{CE} = 3V	$I_C = 10mA$	100	
(Figure 3)			I _C = 10μA	54	
Base-to-Emitter Voltage (Figure 4)	V_{BE}	V _{CE} = 3V	I _E = 1 mA	0.715	V
			I _E = 10mA	0.800	V
V _{BE} Temperature Coefficient (Figure 5)	ΔV _{BE} /ΔΤ	$V_{CE} = 3V$, $I_{C} = 1$ mA		-1.9	mV/ ^o C
Collector-to-Emitter Saturation Voltage	V _{CE} SAT	$I_B = 1 \text{mA}, I_C = 10 \text{mA}$		0.23	V
Noise Figure (Low Frequency)	NF	$f = 1kHz$, $V_{CE} = 3V$, $I_C = 100μA$, $R_S = 1kΩ$		3.25	dB

PARAMETER	SYMBOL	TEST CONDITIONS	TYPICAL VALUES	UNITS
Low-Frequency, Small-Signal Equivalent-Circuit Characteristics:		$f = 1kHz, V_{CE} = 3V, I_{C} = 1mA$		
Forward Current-Transfer Ratio (Figure 6)	h _{FE}		100	-
Short-Circuit Input Impedance (Figure 6)	h _{IE}		3.5	kΩ
Open-Circuit Output Impedance (Figure 6)	h _{OE}		15.6	μS
Open-Circuit Reverse-Voltage Transfer Ratio (Figure 6)	h _{RE}		1.8 X 10 ⁻⁴	-
Admittance Characteristics:		$f = 1MHz, V_{CE} = 3V, I_{C} = 1mA$		
Forward Transfer Admittance (Figure 7)	УFЕ		31 - j1.5	mS
Input Admittance (Figure 8)	УІЕ		0.3 + j0.04	mS
Output Admittance (Figure 9)	УОЕ		0.001 + j0.03	mS
Reverse Transfer Admittance (Figure 10)	УRЕ		See Figure 10	-
Gain-Bandwidth Product (Figure 11)	f _T	$V_{CE} = 3V$, $I_{C} = 3mA$	550	MHz
Emitter-to-Base Capacitance	C _{EBO}	$V_{EB} = 3V, I_{E} = 0$	0.6	pF
Collector-to-Base Capacitance	C _{CBO}	$V_{CB} = 3V, I_{C} = 0$	0.58	pF
Collector-to-Substrate Capacitance	C _{CIO}	$V_{C I} = 3V, I_{C} = 0$	2.8	pF

Typical Performance Curves

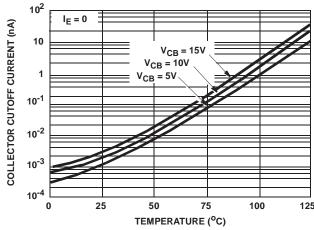


FIGURE 1. I_{CBO} vs TEMPERATURE

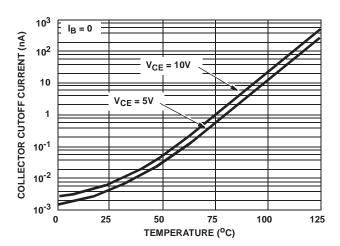
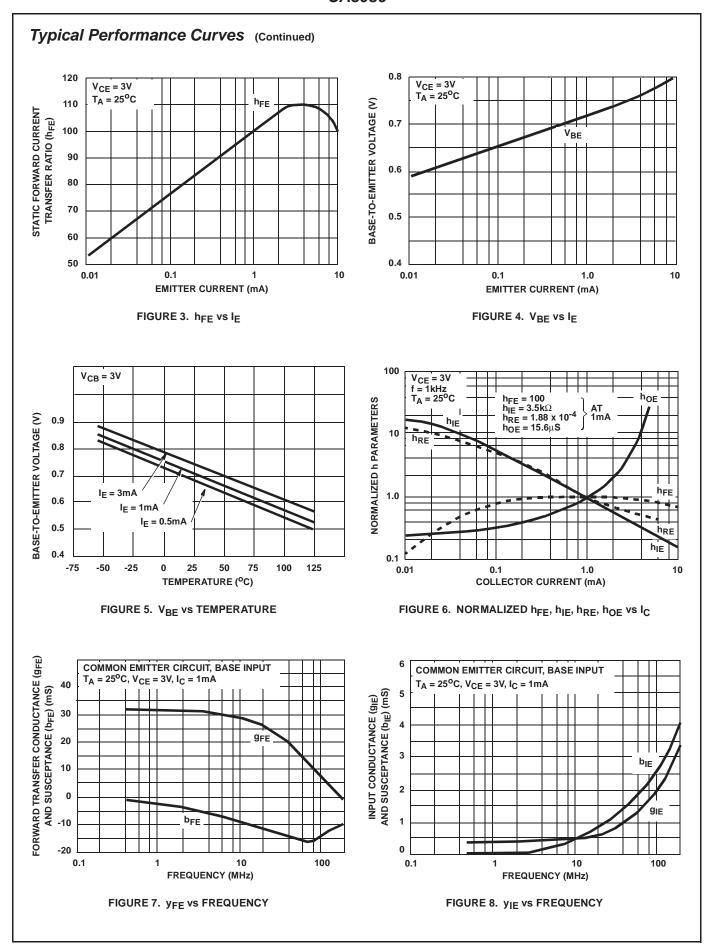
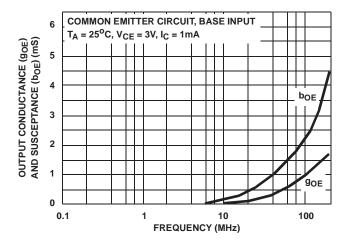


FIGURE 2. I_{CEO} vs TEMPERATURE



Typical Performance Curves (Continued)



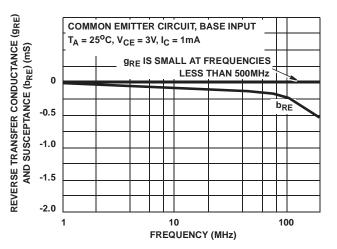


FIGURE 9. yOE vs FREQUENCY

FIGURE 10. y_{RE} vs FREQUENCY

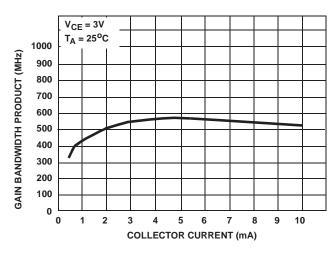


FIGURE 11. f_T vs I_C

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